TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

TC7WT126FU

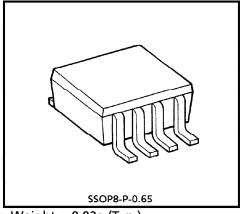
INVERTED, 3-STATE OUTPUT

The TC7WT126FU is a high speed CMOS DUAL BUS BUFFERS fabricated with silicon gate CMOS technology. It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The input threshold levels are compatible with TTL output voltage.

The require 3-state control input G to be set low to place the output into the high impedance.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

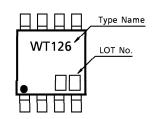


Weight: 0.02g (Typ.)

FEATURES

- High Speed $\cdots t_{pd} = 13ns$ (Typ.) at $V_{CC} = 5V$
- Low Power Dissipation $\cdots I_{CC} = 2\mu A$ (Max.) at Ta = 25°C
- Compatible with TTL outputs ··· V_{IL} = 0.8V (Max.), V_{IH} = 2.0V (Min.)
- Output Drive Capability 15 LSTTL Loads
- Symmetrical Output Impedance… |IOH| = IOL = 6mA (Min.)

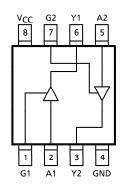
MARKING



MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Supply Voltage Range	Vcc	-0.5~7	V
DC Input Voltage	V _{IN}	-0.5~V _{CC} +0.5	V
DC Output Voltage	Vout	-0.5~V _{CC} +0.5	٧
Input Diode Current	ΙΚ	± 20	mA
Output Diode Current	lok	± 20	mA
DC Output Current	IOUT	± 35	mΑ
DC V _{CC} / Ground Current	Icc	± 37.5	mA
Power Dissipation	PD	300	mW
Storage Temperature	T _{stg}	-65∼150	°C
Lead Temperature (10 s)	TL	260	°C

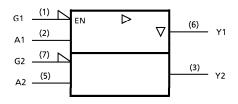
PIN ASSIGNMENT (TOP VIEW)



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LOGIC DIAGRAM



TRUTH TABLE

INP	UTS	OUTPUTS				
G	Α	Y				
L	×	Z				
Н	L	L				
Н	Н	Н				

x : Don't Care Z : High Impedance

RECOMMENDED OPERATING CONDITIONS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Supply Voltage	Vcc	4.5~5.5	V
Input Voltage	V _{IN}	0~V _{CC}	V
Output Voltage	Vout	0~V _{CC}	V
Operating Temperature	T _{opr}	- 40∼85	°C
Input Rise and Fall Time	t _r , t _f	0~500	ns

DC ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	L TEST CONDITION		Vcc	Ta = 25°C			$Ta = -40 \sim 85^{\circ}C$		UNIT	
CHARACTERISTIC STIVIBOL TEST CONDITIO		ONDITION	(V)	MIN.	TYP.	MAX.	MIN.	MAX.	UNII		
High-Level	\/			4.5~	2.0			2.0		V	
Input Voltage	VIH			5.5	2.0	_	_	2.0	-	·	
Low-Level	\/			4.5~			0.0		0.0	V	
Input Voltage	VIL			5.5	_	_	0.8	_	0.8	·	
High-Level	V	Maria Maria	$I_{OH} = -20\mu A$	4.5	4.4	4.5	_	4.4	_	V	
Output Voltage	Voн	$V_{IN} = V_{IH}$	I _{OH} = -6mA	4.5	4.18	4.31	_	4.13	_		
Low-Level	\/ - ·	V _{IN} = V _{IH}	$I_{OL} = 20 \mu A$	4.5	_	0.0	0.10	_	0.10	V	
Output Voltage	VOL	or V _{IL}	I _{OL} = 6mA	4.5	_	0.17	0.26	_	0.33	V	
3-State Output	1	V _{IN} = = V _{IH} or V _{IL} V _{OUT} = V _{CC} or GND		5.5	_	_	± 0.5	_	± 5.0	μ A	
Off-State Current	loz										
Input Leakage	liki	V. V. a. a. CND		I _{IN} V _{IN} = V _{CC} or GND	5.5	_	_	±0.1	_	± 1.0	
Current	IN	AIM - ACC O	I GND	5.5	μ A						
	lcc	V _{IN} = V _{CC} o	5.5	_	_	2.0	_	20.0	μΑ		
Quiescent Supply		PER INPUT : V _{IN} = 0.5V									
Current	^I CCT		or 2.4V	5.5	—	—	2.0	_	2.9	mΑ	
		OTHER INPL									

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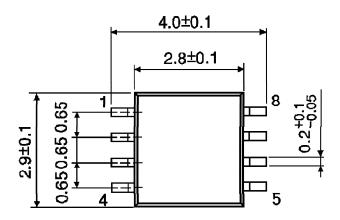
AC ELECTRICAL CHARACTERISTICS (Input $t_r = t_f = 6ns$)

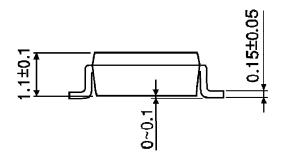
CHADACTERICTIC	SYMBOL	TEST CO	TEST CONDITION		Ta = 25°C			Ta = -40~85°C		LINIT
CHARACTERISTIC	STIVIBOL		CL	Vcc	MIN.	TYP.	MAX.	MIN.	MAX.	UNIT
Output Transition	tTLH tTHL		FO	4.5	_	7	12	-	15	nc
Time		_	50	5.5	_	6	11	_	14	ns
		_	50	4.5	_	15	25	_	31	
Propagation Delay	t _{pLH}			5.5	-	13	22	_	28	ns
Time	tpHL		150	4.5	_	21	33	_	41	
				5.5	_	18	29	_	37	
	^t pZL ^t pZH	$R_L = 1k\Omega$	50 150	4.5	_	17	30	—	38	ns
Output Enable Time				5.5	_	14	27	_	34	
				4.5	_	23	38	_	48	
				5.5	_	20	34	_	43	
Output Disable Time	tpLZ	D. 11.0	50	4.5	_	16	30	_	38	
	tpHZ	$R_L = 1k\Omega$		5.5	_	13	27	_	34	ns
Input Capacitance	CIN	_	_	_	_	5	10	_	10	рF
Output Capacitance	COUT	_	_	_	_	10	_		_	рF
Power Dissipation Capacitance	C _{PD}	(Note 1)	_	_	_	32	_	_	_	pF

(Note 1): CpD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: $|CC(opr)| = CpD \cdot VCC \cdot f|N + |CC|/2$ (per Gate)

OUTLINE DRAWING SSOP8-P-0.65

Unit: mm





Weight: 0.02g (Typ.)